U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE ATTY, DOCKET NO. MI22-2393 Form PTO-1449 PRIORITY SERIAL NO. LIST OF ART CITED BY APPLICANT APPLICANT Fernando Gonzalez (Use several sheets if necessary) PRIORITY FILING DATE PRIORITY GROUP June 12, 2000 U.S. PATENT DOCUMENTS Date Subclass *Examiner Document Name Class Filing Date Number Initial If Appropriate AA 6,251,754 6/01 Kobayashi et al. M AB 6,245,161 6/01 Hentey et al. **ऒ** AC 5,374,581 12/94 Ichikawa et al. E# ΑD 4,891,329 1/90 Reisman et al. 00 AE 6,150,031 11/00 Yonehara 7/00 AF 6,083,324 Henley et al. **(3)** AG : ଜ<u>ୀ</u> ΑН 1 Αl AJ ΑK ΑL AM FOREIGN PATENT DOCUMENTS Date Class Subclass Translation Document Country Number Yes No AN ΑO ΑP AQ AR OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.) ΑT EXAMINER DATE CONSIDERED *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Form PTO-1449	,	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY. DOCKET NO. MI22-2393		109/592	PRIORITY SERIAL NO.	
		LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)			APPLICANT Fernando Gonzalez			10/659,596	
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